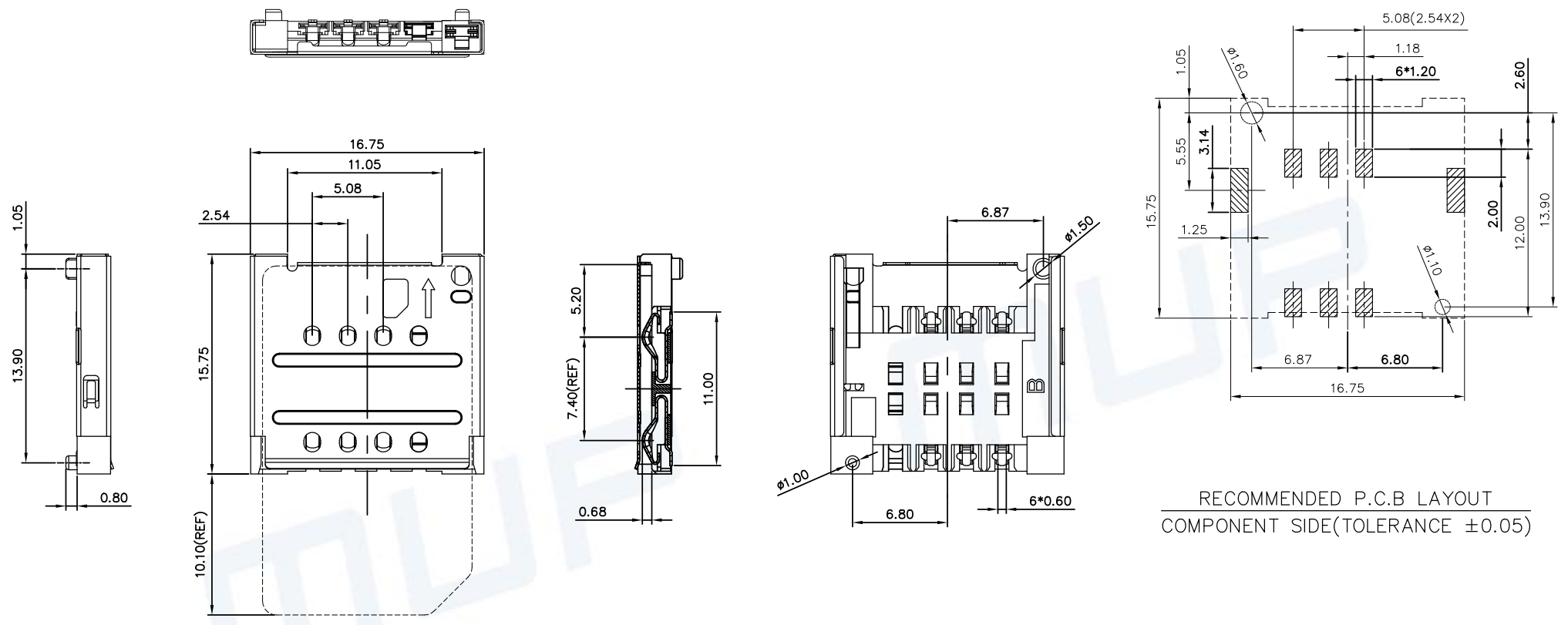
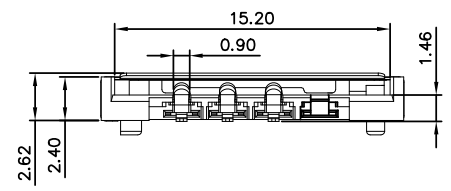


REV.	DESCRIPTION OF REVISIONS	APPR.	CHKD.	DRAW.	DATE
△	NEW			Huabo	2018/3/2
△	Original Model C722-3			HXR	2023/10/19



RECOMMENDED P.C.B LAYOUT  
COMPONENT SIDE(TOLERANCE ±0.05)



TECHNICAL CHARACTERISTICS

- General Characteristics  
Dimensions: 16.75LX15.75WX2.60H mm  
Weight: Approx. g  
Durability: 5,000 cycles min.
- Electrical Characteristics  
Contact resistance: 50mΩ typical, 100mΩ max  
Insulation resistance: >1000MΩ/500V DC
- Solderability  
Vaporphase: 215°C, 30sec. Max  
IR reflow: 250°C, 5sec. Max  
Manual soldering: 370°C, 3sec. Max
- Environmental Characteristics  
Operating temperature: -40°C~+85°C  
Operating humidity: 10%~+95%RH

ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	HOUSING	1	Hi-temp Thermoplastic	Black UL94V-0
2	DATA CONTACT	6	Copper Alloy	Contact area: Gold plated
3	SHELL	1	Stainless Steel	SMT area: Ni plated

Unless otherwise specified, other tolerance are:

X	±0.35	X*	±5°
X.X	±0.25	X.X*	±4°
X.XX	±0.15	X.XX*	±3°
X.XXX	±0.10	X.XXX*	±2°

**MUP** MUP INDUSTRIAL CO.,LTD.

NAME: **SIM Card Connector**

MODEL NO: **MUP-C7022-03**

TYPE: **H2.60 W/Post W/O logo 6P/With Shell**

PROJ.	UNIT	SCALE	DRAWN	Huabo 2018/3/2	DWG NO.:	DWG-C7022-03-01	
	mm	1:1	CHECKED	Huabo 2018/3/2	SHEET	1/1	
CUSTOMER DRAWING			APPROVAL	WANG 2018/3/2	REVISION	2	

